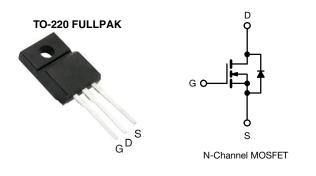
Vishay Siliconix



Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	60	
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.050
Q _g (Max.) (nC)	46	
Q _{gs} (nC)	11	
Q _{gd} (nC)	22	
Configuration	Sing	le

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to lead creepage distance = 4.8 mm
- 175 °C operating temperature
- Dynamic dV/dt rating
- Low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFIZ34GPbF

ABSOLUTE MAXIMUM RATINGS T _C =	= 25 °C, unl	ess otherwis	e noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	60	V	
Gate-source voltage		V _{GS}	± 20	V		
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C	1	20		
Continuous drain current	VGS AL TO V	T _C = 100 °C	I _D	14	А	
Pulsed drain current ^a			I _{DM}	80		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	300	mJ	
Maximum power dissipation	T _C =	25 °C	PD	42	W	
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	- °C	
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mounting torque	6.00.0*	6-32 or M3 screw		10	lbf ∙ in	
Mounting torque	6-32 OF	via screw		1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 875 µH, R_G = 25 Ω , I_{AS} = 20 A (see fig. 12)

c. $I_{SD} \le 30$ A, dI/dt ≤ 200 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

S21-0474-Rev. B, 17-May-2021



COMPLIANT

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PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		65				
Maximum junction-to-case (drain)	R _{thJC}	- 3.6			- °C/W			
	place otherwi	as noted						
SPECIFICATIONS T _J = 25 °C, u PARAMETER	SYMBOL				MIN.	TYP.	MAX.	
Static	OTMDOL	120	I CONDITI				IIIAA.	CINI
Drain-ssource breakdown voltage	V _{DS}	Vcs	= 0 V, I _D = 2	50 µA	60	-	-	v
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C,		-	0.065	_	V/°C
Gate-source threshold voltage	V _{GS(th)}		= V _{GS} , I _D = 2		2.0	-	4.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 20$	•	-	-	± 100	nA
Ĵ	000		= 60 V, V _{GS}		-	-	25	μA
Zero gate voltage drain current	I _{DSS}			T _J = 150 °C	-	-	250	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	1	= 12 A ^b	-	-	0.050	Ω
Forward transconductance	g _{fs}		= 25 V, I _D =	12 A ^b	9.2	-	-	S
Dynamic								1
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	1200	-	-	
Output capacitance	C _{oss}			-	600	-		
Reverse transfer capacitance	C _{rss}	f = 1.	.0 MHz, see	fig. 5	-	100	-	pF
Drain to sink capacitance	С		f = 1.0 MHz	2	-	12	-	
Total gate charge	Qg				-	-	46	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 30$	A, V _{DS} = 48 V . 6 and 13 ^b	-	-	11	nC
Gate-drain charge	Q _{gd}		See ng	1. 0 anu 13 °	-	-	22	1
Turn-on delay time	t _{d(on)}				-	13	_	<u> </u>
Rise time	t _r		= 30 V, I _D =		-	100	-	1
Turn-off delay time	t _{d(off)}		12 Ω , R _D = see fig. 10 ¹		-	29	-	ns
Fall time	t _f	1	occ ng. re		-	52	-	1
Internal drain inductance	L _D	Between l 6 mm (0.25	") from		-	4.5	-	
Internal source inductance	Ls	package and center of die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs				<u> </u>	1		
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20		
Pulsed diode forward current ^a	I _{SM}			-	-	80	A	
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 20 A,	V _{GS} = 0 V ^b	-	-	1.6	V
Body diode reverse recovery time	t _{rr}	T 05 00 1	00 1 11	1 400 A / b	-	120	230	ns
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$	= 30 A, dl/d	lt = 100 A/µs ^b	-	0.70	1.4	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time i	s negligible (turn	-on is dor	ninated b	vls and	[D]

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

2

Document Number: 91188



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

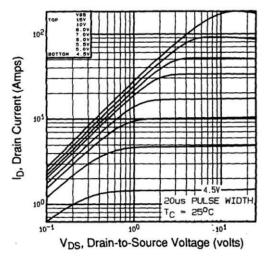


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

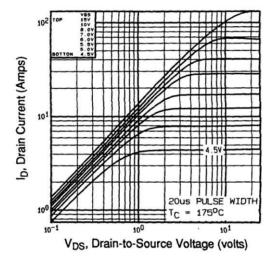


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

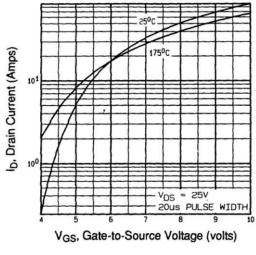


Fig. 3 - Typical Transfer Characteristics

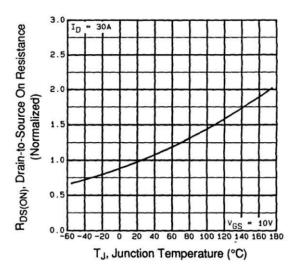


Fig. 4 - Normalized On-Resistance vs. Temperature



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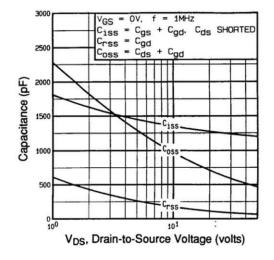


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

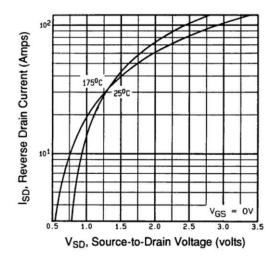


Fig. 7 - Typical Source-Drain Diode Forward Voltage

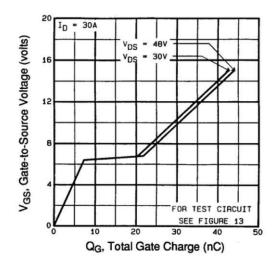


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

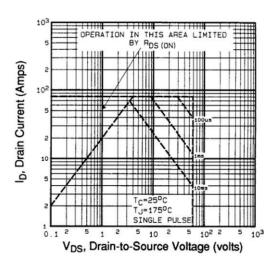
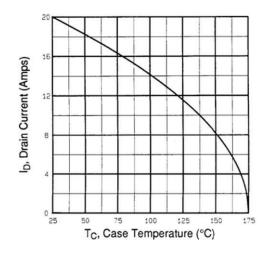


Fig. 8 - Maximum Safe Operating Area

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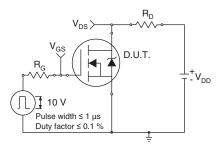


Fig. 10a - Switching Time Test Circuit

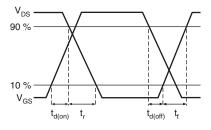


Fig. 10b - Switching Time Waveforms

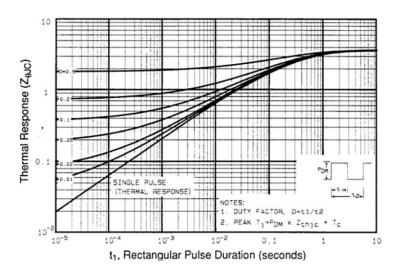


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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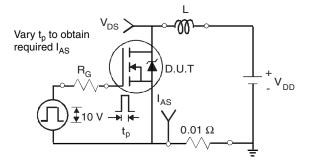


Fig. 12a - Unclamped Inductive Test Circuit

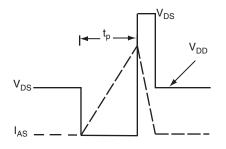


Fig. 12b - Unclamped Inductive Waveforms

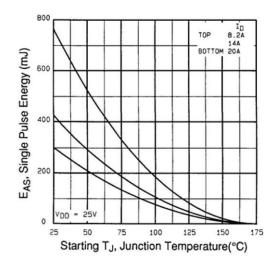
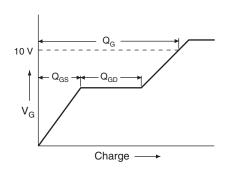


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





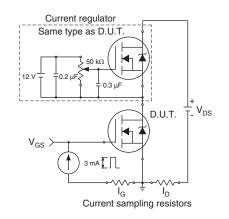
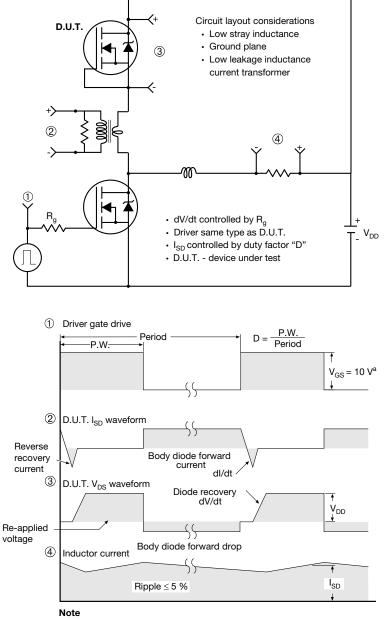


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

2

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